

DMN6070SFCL-7 Datasheet



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DiGi Electronics Part Number DMN6070SFCL-7-DG

Manufacturer Diodes Incorporated

Manufacturer Product Number DMN6070SFCL-7

Description MOSFET N-CH 60V 3A X1-DFN1616-6

Detailed Description N-Channel 60 V 3A (Ta) 600mW (Ta) Surface Mount

X1-DFN1616-6 (Type E)



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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
DMN6070SFCL-7	Diodes Incorporated
Series:	Product Status:
	Active
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
60 V	3A (Ta)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
4V, 10V	85mOhm @ 1.5A, 10V
Vgs(th) (Max) @ ld:	Gate Charge (Qg) (Max) @ Vgs:
3V @ 250μA	12.3 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±20V	606 pF @ 20 V
FET Feature:	Power Dissipation (Max):
	600mW (Ta)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
X1-DFN1616-6 (Type E)	6-PowerUFDFN
Base Product Number:	
DMN6070	

Environmental & Export classification

8541.21.0095

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	1 (Unlimited)
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	





DMN6070SFCL

60V N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)} max	I _D max T _A = +25°C
00)/	$85 \mathrm{m}\Omega$ @ V_{GS} = $10 \mathrm{V}$	3.0A
60V	120 m Ω @ V _{GS} = 4V	2.5A

Description

This new generation MOSFET has been designed to minimize the onstate resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- Power Management Functions
- Analog Switch



Top View

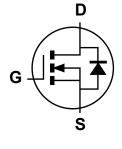
Bottom View

Features and Benefits

- Typical off board profile of 0.5mm ideally suited for thin applications
- Low R_{DS(ON)} minimizes conduction losses
- PCB footprint of 2.56mm²
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 standards for High Reliability

Mechanical Data

- Case: X1-DFN1616-6 Type E
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Lead Free Plating (NiPdAu Finish over Copper leadframe)
- Terminals: Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.04 grams (approximate)



Pin 1

Device Symbol

Top View Pin-Out

D

D

S

Ordering Information (Note 4)

Product	Reel size (inches)	Tape Width (mm)	Quantity per Reel
DMN6070SFCL-7	7	8	3,000

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html

Marking Information



N60 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: A = 2013) M = Month (ex: 9 = September)

Date Code Key

Year	201	1	2012		2013	20	14	2015		2016		2017
Code	Υ		Z		Α	E	3	С		D		E
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



DMN6070SFCL

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Drain-Source Voltage	V_{DSS}	60	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current (Note 6) V _{GS} = 10V	I _D	3.0 2.5	А
Pulsed Drain Current (10µs pulse, Duty cycle = 1%)	I _{DM}	10	А

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

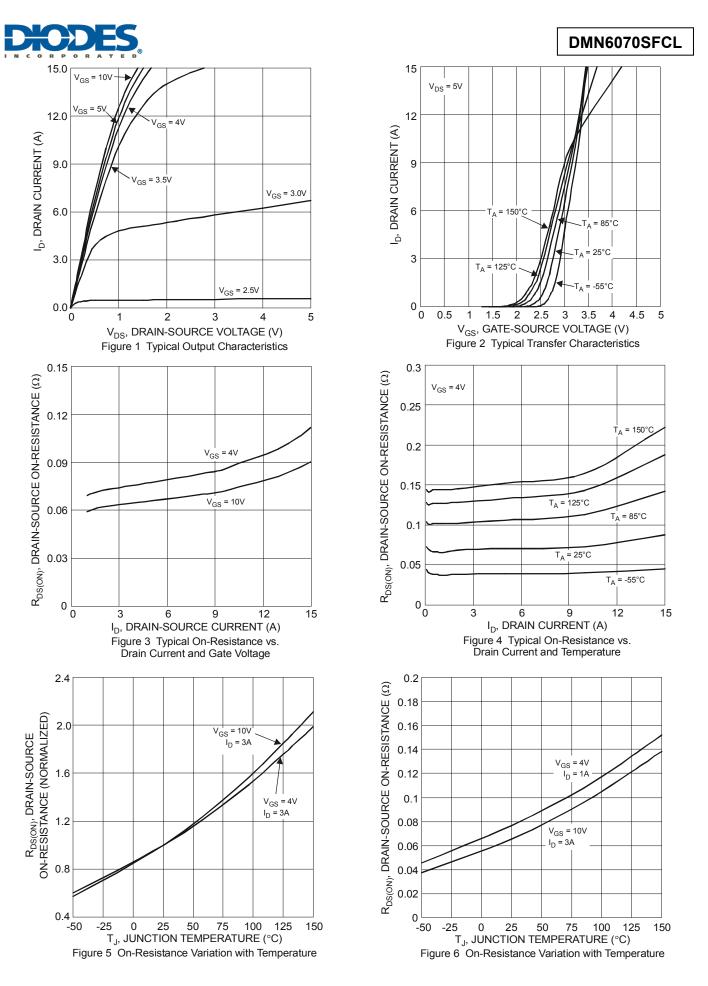
Characteristic		Symbol	Value	Units	
Total Bower Dissinction	(Note 5)	Б	0.6	W	
Total Power Dissipation	(Note 6)	P_D	1.8	W	
Thermal Desistance Investiga to Austriant	(Note 5)	-	200	°C/M	
Thermal Resistance, Junction to Ambient	(Note 6)	$R_{ heta JA}$	67	°C/W	
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C	

Electrical Characteristics N-CHANNEL (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)	Cymbol		136	Wax	Onic	rest condition	
Drain-Source Breakdown Voltage	BV _{DSS}	60	_	_	V	$V_{GS} = 0V, I_D = 250\mu A$	
Zero Gate Voltage Drain Current T _J = +25°C	I _{DSS}	_	_	1.0	μΑ	V _{DS} = 60V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	V _{GS} = ±16V, V _{DS} = 0V	
ON CHARACTERISTICS (Note 7)						•	
Gate Threshold Voltage	V _{GS(th)}	1	_	3	V	V _{DS} = V _{GS} , I _D = 250μA	
Static Drain-Source On-Resistance	B		67	85	mΩ	V _{GS} = 10V, I _D = 1.5A	
Static Dialit-Source Off-Resistance	R _{DS (ON)}	_	74	120	11122	$V_{GS} = 4V, I_D = 0.5A$	
Forward Transfer Admittance	Y _{fs}	_	2.6	_	S	$V_{DS} = 5V, I_{D} = 1.5A$	
Diode Forward Voltage	V_{SD}	_	0.7	1.2	V	$V_{GS} = 0V$, $I_S = 3A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	C _{iss}	_	606	_	pF		
Output Capacitance	Coss	_	32.6	_	pF	$V_{DS} = 20V, V_{GS} = 0V,$ $V_{DS} = 1.0MHz$	
Reverse Transfer Capacitance	C _{rss}	_	24.6	_	pF	1 - 1.0WH12	
Gate Resistance	Rg	_	1.5	_	Ω	V_{DS} = 0V, V_{GS} = 0V, f = 1MHz	
Total Gate Charge (V _{GS} =10V)	Qg	_	12.3	_	nC		
Total Gate Charge (V _{GS} =4.5V)	Qg	_	5.6	_	nC	$V_{DS} = 30V, I_D = 3A$	
Gate-Source Charge	Q _{gs}	_	1.7	_	nC	VDS - 30V, ID - 3A	
Gate-Drain Charge	Q_{gd}	_	1.9	_	nC		
Turn-On Delay Time	t _{D(on)}	_	3.5	_	ns		
Turn-On Rise Time	t _r		4.1	_	ns	V_{GS} = 10V, V_{DS} = 30V,	
Turn-Off Delay Time	t _{D(off)}	_	35	_	ns	$R_G = 20\Omega$, $R_L = 50\Omega$	
Turn-Off Fall Time	t _f	_	11	_	ns		

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout

Device mounted on FR-4 substrate PC board, 20z copper, with thermal vias to bottom layer 1inch square copper plate
 Short duration pulse test used to minimize self-heating effect.
 Guaranteed by design. Not subject to product testing.



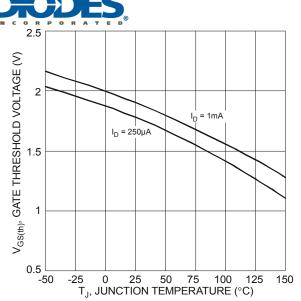
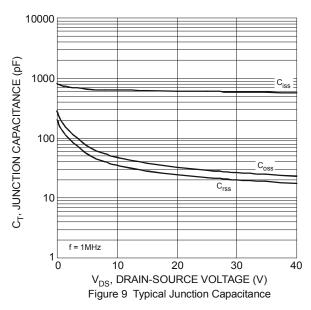
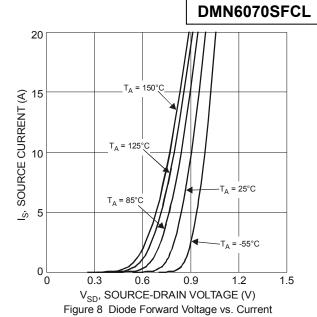
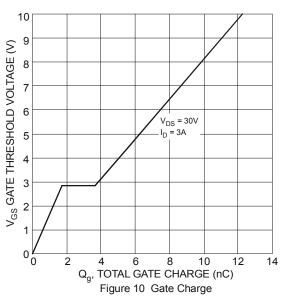


Figure 7 Gate Threshold Variation vs. Ambient Temperature

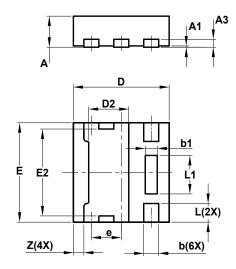






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



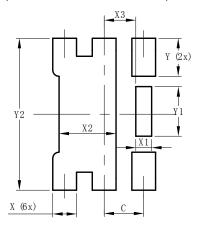
X1-DFN1616-6 Type E							
Dim							
Α	0.47	0.53	0.50				
A1	0	0.05	0.02				
A3	_	_	0.13				
b	0.20	0.30	0.25				
b1	0.10	0.30	0.20				
D	1.55	1.65	1.60				
D2	0.57	0.77	0.67				
Е	1.55	1.65	1.60				
E2	1.30	1.50	1.40				
е			0.50				
L	0.25	0.35	0.30				
L1	0.52	0.72	0.62				
Z	_	_	0.175				
All [Dimens	ions in	mm				



DMN6070SFCL

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for latest version.



Dimensions	Value (in mm)
С	0.500
Х	0.300
X1	0.200
X2	0.720
Х3	0.400
Y	0.475
Y1	0.620
Y2	1.900

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